



Latest Advances and Applications of Food Packaging Materials

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Message from the Guest Editors

As a consequence of the growth in the population and the improving quality of life, food demand will double by 2050. One way to meet this requirement is to reduce food losses from the supply chain. In this context, new food packaging materials that have good barrier properties against water vapors and gases will play a key role in meeting the growing food demands. On the other hand, non-biodegradable plastics that are commonly used for food packaging have created daunting challenges such as overburdened landfills and the proliferation of ocean microplastics. This Special issue aims to cover the latest advances and applications of food packaging materials. We highly welcome articles describing scientific or engineering advancements in the field of food packaging materials.





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Message from the Editor-in-Chief

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